## **BOARD-TO-BOARD HEADERS & RECEPTACLES**





✓ Active

<u>+</u>

PRODUCT DRAWING



3D PDF

TE CONNECTIVITY (TE)

02 MODII HORZ SR CE 100CL

AMPMODU | AMPMODU

535676-1

TE Internal Number: 535676-1

Not EU RoHS or ELV Compliant Find Compliant Alternatives

Connector Style Receptacle

Centerline **2.54 mm [.1 in ]** 

Number of Positions 2

Packaging Method Tube, Tube/Box

Contact Mating Area Plating Material Gold

Product Drawings AMPMODU MOD II RECEPTACLE ASSEMBLY, HORIZONTAL, .100 CL, SINGLE

ROW, CLOSED-ENTRY, SHORT POINT OF CONTACT, END-TO-END STACKABLE

PDF **English** 

CAD Files Customer View Model

3D\_IGS.ZIP English

Customer View Model

2D\_DXF.ZIP **English** 

3D PDF PDF English

Customer View Model

3D\_STP.ZIP **English** 

**Product Specifications** 

Product Specification AMPMODU MOD II Interconnection System

PDF English

Application Specification AMPMODU Mod II And Mod IV Printed Circuit Board Connectors

PDF **English** 

Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

**Product Type Features** 

Connector Style

Receptacle

PCB Mounting Orientation

Right Angle

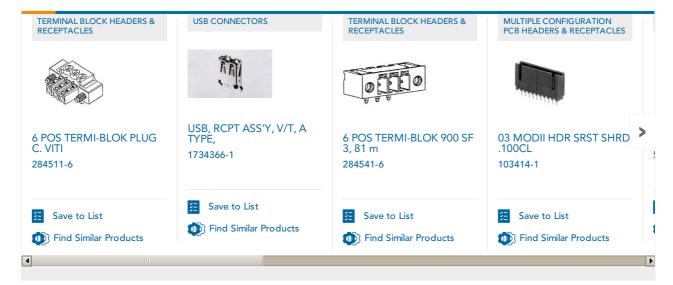
Row-to-Row Spacing

7.87 mm [ .31 in ]

	Applied Pressure	High, Standard	
	Profile	Standard Connector	
	Product Type		
	Applies To	Printed Circuit Board	
	Boss	Without	
	Series	AMPMODU, MOD II	
	Sealed	No	
	Connector Type	Connector Assembly	
Configuration Features	Number of Positions	2	
Configuration realures			
	Number of Rows	1	
	Stackable	Yes	
Electrical Characteristics	Voltage (VAC)	333	
	Contact Resistance (M $\Omega$ )	12	
	Insulation Resistance (M $\Omega$ )	5000	
	Dielectric Withstanding Voltage (VAC)	750	
Contact Features	Contact Mating Area Plating Material	Gold	
	Contact Mating Area Plating Thickness (µin)	30	
	Contact Shape	Square	
	Contact Current Rating (A)	2	
	Contact Type	Socket	
	Contact Configuration	Short Point	
	Solder Tail Contact Plating Material	Tin-Lead over Nickel	
	Contact Layout	Inline	
	Solder Tail Contact Plating Thickness (µin)	50	
	Contact Base Material	Phosphor Bronze	
Termination Features	Termination Method to PC Board	Through Hole - Solder	
	Termination Post Length	2.92 mm [ .115 in ]	
Mechanical Attachment	PCB Mount Retention	Without	
Housing Features	Centerline	2.54 mm [ .1 in ]	
	Housing Material	Polyester - GF	

Dimensions	Height	3.47 mm [ .136 in ]
	PCB Thickness (Recommended)	1.4 – 2.4 mm [ .055 – .094 in ]
	Tail Length (mm)	2.92
Jsage Conditions	Operating Temperature Range (°C)	-65 – 105
	High Temperature Compatible	Yes
Operation/Application	Assembly Process Feature	Board Standoff
	For Use With	Mates with Headers
Industry Standards	UL Flammability Rating	UL 94V-0
	MIL-C-55032	No
	Approved Standards	CSA LR7189, UL E28476
Packaging Features	Packaging Method	Tube, Tube/Box
	Packaging Quantity	110
Other	Comment	TE recommends mating gold or duplex plated headers with duplex plated receptacle assemblies.
Product Compliance	Statement of Compliance	

## **CUSTOMERS ALSO BOUGHT**



VIEW ALL PRODUCT COMPLIANCE

## **Mouser Electronics**

**Authorized Distributor** 

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TE Connectivity: 535676-1